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December 2001

## FDC606P

**FAIRCHILD** 

## P-Channel 1.8V Specified PowerTrench<sup>®</sup> MOSFET

## **General Description**

This P-Channel 1.8V specified MOSFET uses Fairchild's low voltage PowerTrench process. It has been optimized for battery power management applications.

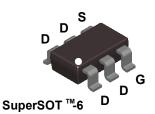
## Applications

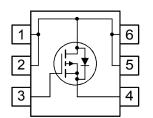
- Battery management
- Load switch
- Battery protection

## Features

• -6 A, -12 V.

- Fast switching speed
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$





## Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		-12	V
V <sub>GSS</sub>	Gate-Source Voltage		±8	V
ID	Drain Current – Continuous	(Note 1a)	-6	A
	– Pulsed		-20	
P <sub>D</sub>	Maximum Power Dissipation	(Note 1a)	1.6	W
		(Note 1b)	0.8	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature	Range	–55 to +150	°C

R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

## Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
.606	FDC606P	7"	8mm	3000 units

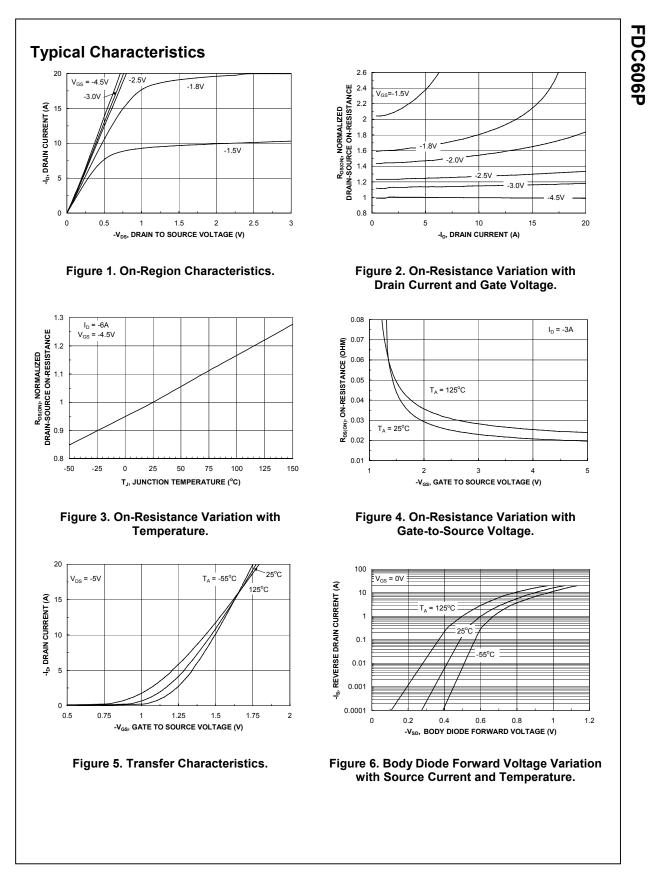
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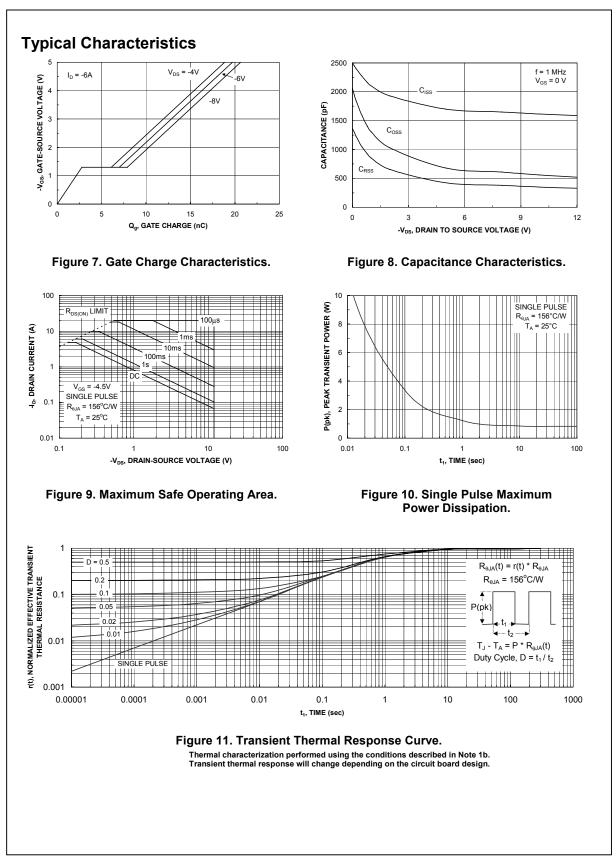
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = -250 \mu A$	-12			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D$ = -250 µA,Referenced to 25°C		-3		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -10 V$ , $V_{GS} = 0 V$			-1	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 8 V$ , $V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Chai	racteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-0.4	-0.5	-1.5	V
<u>ΔV<sub>GS(th)</sub></u> ΔT <sub>J</sub>	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		2.5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{\rm GS} = -4.5 \ V, & I_{\rm D} = -6 \ A \\ V_{\rm GS} = -2.5 \ V, & I_{\rm D} = -5 \ A \\ V_{\rm GS} = -1.8 \ V, & I_{\rm D} = -4 \ A \\ V_{\rm GS} = -4.5 \ V, \ I_{\rm D} = -6 \ A, T_{\rm J} = 125^{\circ} C \end{array} $		21 26 34 28	26 35 53 35	mΩ
D(on)	On–State Drain Current	$V_{GS} = -4.5 V$ , $V_{DS} = -5 V$	-20			Α
<b>g</b> fs	Forward Transconductance	$V_{DS} = -5 V$ , $I_{D} = -6 A$		25		S
Dynami	c Characteristics					
Ciss	Input Capacitance	$V_{DS} = -6 V$ , $V_{GS} = 0 V$ ,		1699		pF
Coss	Output Capacitance	f = 1.0 MHz		679		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			423		pF
Switchir	ng Characteristics (Note 2)					
d(on)	Turn–On Delay Time	$V_{DD} = -6 V$ , $I_D = -1 A$ ,		11	19	ns
·r	Turn–On Rise Time	$V_{DD} = -6 V,$ $I_D = -1 A,$ $V_{GS} = -4.5 V,$ $R_{GEN} = 6 \Omega$		10	20	ns
d(off)	Turn–Off Delay Time			89	142	ns
f	Turn–Off Fall Time			70	112	ns
٦g	Total Gate Charge	$V_{DS} = -6 V$ , $I_{D} = -6 A$ ,		18	25	nC
Q <sub>gs</sub>	Gate–Source Charge	$V_{GS} = -4.5 V$		3		nC
	Gate-Drain Charge			4.2		nC
Q <sub>gd</sub>		and Maximum Ratings				
<sub>Q₀d</sub> Drain–S	ource Diode Characteristics		-			٨
0	ource Diode Characteristics				-1.3	A

b. 156°C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width  $\leq 300~\mu\text{s},~\text{Duty}~\text{Cycle} \leq 2.0\%$ 



FDC606P Rev E (W)



FDC606P

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